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Key IoT Technologies: Unlocking the IoT Potential

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Abstracts

This report identifies the emerging IoT technologies.

For each of them, it also analyses their:

Operating principle including advantages and drawbacks

Drivers and barriers

Adoption and related impacts for:

Verticals (both device manufacturers and end users)

Main IoT solution providers along the value chain

Finally, it also provides market estimates and forecasts in terms of annual shipments, for each technology at worldwide levels.

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